# SKiiP 03NEB066V1



1-phase bridge rectifier + brake chopper + 3-phase bridge inverter SKiiP 03NEB066V1

Target Data

### **Features**

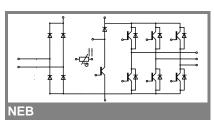
- Trench IGBTs
- Robust and soft freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognised file no. E63532

### **Typical Applications**

- Inverter up to 5,6 kVA
- Typical motor power 3,0 kW

#### Remarks

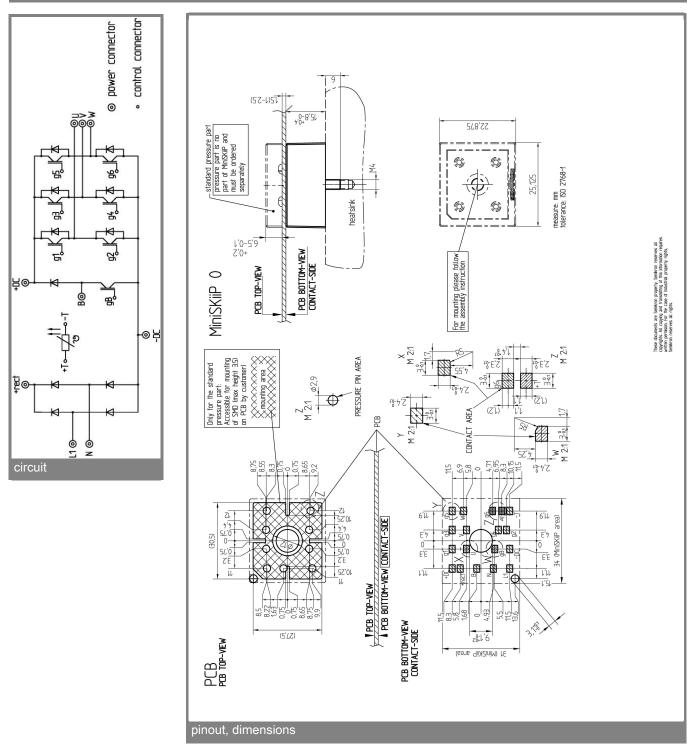
- Case temperature limited to T<sub>C</sub> = 125°C max.
- · Product reliability results are valid
- for T<sub>j</sub>=150°C SC data:  $t_p \le 6 \ \mu s; \ V_{GE} \le 15 \ V; \ T_j$ = 150°C;  $V_{CC}$  = 360 V  $V_{CEsat}, \ V_F$  = chip level value



Absolute	Maximum Ratings	T <sub>s</sub> = 25 °C, unless otherwis	$T_s = 25 \text{ °C}$ , unless otherwise specified	
Symbol	Conditions	Values	Units	
IGBT - Inverter, Chopper				
V <sub>CES</sub>		600	V	
I <sub>C</sub>	T <sub>s</sub> = 25 (70) °C, T <sub>j</sub> = 150 °C	22 (17)	Α	
I <sub>C</sub>	T <sub>s</sub> = 25 (70) °C, T <sub>j</sub> = 175 °C	23 (19)	A	
I <sub>CRM</sub>	t <sub>p</sub> = 1 ms	30	Α	
V <sub>GES</sub>		± 20	V	
	nverter, Chopper	•		
I <sub>F</sub>	T <sub>s</sub> = 25 (70) °C, T <sub>i</sub> = 150 °C	20 (15)	А	
I <sub>F</sub>	T <sub>s</sub> = 25 (70) °C, T <sub>i</sub> = 175 °C	22 (18)	А	
I <sub>FRM</sub>	t <sub>p</sub> = 1 ms	30	А	
Diode - F	Rectifier			
V <sub>RRM</sub>		800	V	
I <sub>F</sub>	T <sub>s</sub> = 70 °C	35	А	
I <sub>FSM</sub>	t <sub>p</sub> = 10 ms, sin 180 °, T <sub>i</sub> = 25 °C	220	А	
i²t	t <sub>p</sub> = 10 ms, sin 180 °, T <sub>j</sub> = 25 °C	240	A²s	
I <sub>tRMS</sub>	per power terminal (20 A / spring)	20	А	
Tj	IGBT, Diode	-40+175	°C	
T <sub>stg</sub>		-40+125	°C	
V <sub>isol</sub>	AC, 1 min.	2500	V	

$\begin{array}{ c c c c c c } \hline Symbol & Conditions & min. typ. max. \\ \hline IGBT - Inverter, Chopper \\ V_{CE(sat)} &  _{Cnom} = 15 \text{ A}, T_j = 25 (150)  ^{\circ}\text{C} & 1,45 (1,65)  1,85 (2,05) \\ V_{GE(th)} & V_{GE} = V_{CE}, I_C = 1  \text{mA} & 5,8 \\ V_{CE(TO)} & T_j = 25 (150)  ^{\circ}\text{C} & 0,9 (0,85)  1 (0,9) \\ r_{CE} & T_j = 25 (150)  ^{\circ}\text{C} & 0,9 (0,85)  1 (0,9) \\ r_{Ce} & V_{CE} = 25  V, V_{GE} = 0  V,  f = 1  \text{MHz} & 0,86 \\ c_{oes} & V_{CE} = 25  V, V_{GE} = 0  V,  f = 1  \text{MHz} & 0,18 \\ c_{res} & V_{CE} = 25  V, V_{GE} = 0  V,  f = 1  \text{MHz} & 0,12 \\ R_{CC'+EE'} & \text{spring contact-chip } T_s = 25 (150)  ^{\circ}\text{C} & R_{th(j\cdots)} & \text{per IGBT} & 1,8 \\ \hline t_{d(on)} & \text{under following conditions} & 20 \\ \hline \end{array}$	Units V V V mΩ nF nF nF mΩ			
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	V V nF nF nF			
$ \begin{array}{c c c c c c c c c c } V_{GE} & V_{GE} = V_{CE}, I_C = 1 \text{ mA} & 5,8 & \\ V_{CE(TO)} & T_j = 25 (150)  ^\circ \text{C} & 0,9 (0,85) & 1 (0,9) & \\ r_{CE} & T_j = 25 (150)  ^\circ \text{C} & 40 (57) & 60 (80) & \\ \hline C_{ies} & V_{CE} = 25  \text{V}, V_{GE} = 0  \text{V}, f = 1  \text{MHz} & 0,86 & \\ \hline C_{oes} & V_{CE} = 25  \text{V}, V_{GE} = 0  \text{V}, f = 1  \text{MHz} & 0,18 & \\ \hline C_{res} & V_{CE} = 25  \text{V}, V_{GE} = 0  \text{V}, f = 1  \text{MHz} & 0,12 & \\ \hline R_{C'+EE'} & \text{spring contact-chip } T_s = 25 (150)  ^\circ \text{C} & \\ \hline R_{th(j;s)} & \text{per IGBT} & 1,8 & \\ \end{array} $	V V nF nF nF			
$ \begin{array}{c c c c c c c c c c } V_{GE} = V_{CE}, I_C = 1 \text{ mA} & 5,8 & \\ V_{CE(TO)} & T_j = 25 (150)  ^\circ \text{C} & 0,9 (0,85) & 1 (0,9) & \\ r_{CE} & T_j = 25 (150)  ^\circ \text{C} & 40 (57) & 60 (80) & \\ C_{ies} & V_{CE} = 25  \text{V}, V_{GE} = 0  \text{V}, f = 1  \text{MHz} & 0,86 & \\ C_{oes} & V_{CE} = 25  \text{V}, V_{GE} = 0  \text{V}, f = 1  \text{MHz} & 0,18 & \\ C_{res} & V_{CE} = 25  \text{V}, V_{GE} = 0  \text{V}, f = 1  \text{MHz} & 0,12 & \\ R_{CC'+EE'} & \text{spring contact-chip } T_s = 25 (150)  ^\circ \text{C} & \\ R_{th(j\cdots)} & \text{per IGBT} & 1,8 & \\ \end{array} $	V mΩ nF nF nF			
$ \begin{array}{c c} r_{CE} & T_{j}^{1} = 25 \ (150) \ ^{\circ}\text{C} & 40 \ (57) \ 60 \ (80) \\ \hline C_{ies} & V_{CE} = 25 \ V, \ V_{GE} = 0 \ V, \ f = 1 \ \text{MHz} & 0, 86 \\ \hline C_{oes} & V_{CE} = 25 \ V, \ V_{GE} = 0 \ V, \ f = 1 \ \text{MHz} & 0, 18 \\ \hline C_{res} & V_{CE} = 25 \ V, \ V_{GE} = 0 \ V, \ f = 1 \ \text{MHz} & 0, 12 \\ \hline R_{C'+EE'} & \text{spring contact-chip } \ T_{s} = 25 \ (150) \ ^{\circ}\text{C} \\ \hline R_{th(j-s)} & \text{per IGBT} & 1, 8 \end{array} $	mΩ nF nF nF			
$ \begin{array}{c c} C_{ies} & V_{CE} = 25 \ V, V_{GE} = 0 \ V, \ f = 1 \ MHz & 0,86 \\ C_{oes} & V_{CE} = 25 \ V, \ V_{GE} = 0 \ V, \ f = 1 \ MHz & 0,18 \\ C_{res} & V_{CE} = 25 \ V, \ V_{GE} = 0 \ V, \ f = 1 \ MHz & 0,12 \\ R_{CC'+EE'} & \text{spring contact-chip } T_s = 25 \ (150 \ )^{\circ}C \\ R_{th(j-s)} & \text{per IGBT} & 1,8 \\ \end{array} $	nF nF nF			
$ \begin{array}{c c} C_{oes} & V_{CE} = 25 \ V, \ V_{GE} = 0 \ V, \ f = 1 \ MHz & 0,18 \\ C_{res} & V_{CE} = 25 \ V, \ V_{GE} = 0 \ V, \ f = 1 \ MHz & 0,12 \\ R_{CC'+EE'} & spring \ contact-chip \ T_s = 25 \ (150 \ )^{\circ}C \\ R_{th(j-s)} & per \ IGBT & 1,8 \\ \end{array} $	nF nF			
	nF			
$R_{CC'+EE'}$ spring contact-chip T_s = 25 (150)°C $R_{th(j-s)}$ per IGBT1,8				
R <sub>th(j-s)</sub> per IGBT 1,8	mΩ			
type 1 under following conditions 20	K/W			
u(on)	ns			
$t_r = V_{CC} = 300 \text{ V}, \text{ V}_{GE} = \pm 15 \text{ V}$ 30	ns			
$t_{d(off)}$ I <sub>Cnom</sub> = 15 A, T <sub>j</sub> = 150 °C 155	ns			
$t_f = R_{Gon} = R_{Goff} = 22 \Omega$ 45	ns			
E <sub>on</sub> (E <sub>off</sub> ) inductive load 0,6 (0,5)	mJ			
Diode - Inverter, Chopper				
$V_F = V_{EC}$ $I_F = 15 \text{ A}, T_1 = 25 (150) ^{\circ}\text{C}$ 1,4 (1,4) 1,7 (1,7)	V			
$V_{(TO)}$ T <sub>j</sub> = 25 (150) °C 1 (0,9) 1,1 (1)	V			
$r_{T}$ $T_{j} = 25 (150) ^{\circ}\text{C}$ 27 (34) 40 (47)	mΩ			
R <sub>th(j-s)</sub> per diode 2,5	K/W			
I <sub>RRM</sub> under following conditions 19,8	А			
$Q_{rr}$ I <sub>Fnom</sub> = 15 A, V <sub>R</sub> = 300 V 1,9	μC			
$E_{rr}$ $V_{GE} = 0 V, T_{i} = 150^{\circ}C$ 0,5	mJ			
$di_{\rm F}/dt = 930$ Å/µs				
Diode - Rectifier	_ <b>.</b>			
V <sub>F</sub> I <sub>Fnom</sub> = 15 A, T <sub>i</sub> = 25 °C 1,1	V			
$V_{(TO)}$ T <sub>i</sub> = 150 °C 0,8	V			
$r_{\rm T}$ $T_{\rm j} = 150 ^{\circ}{\rm C}$ 20	mΩ			
R <sub>th(j-s)</sub> per diode 1,5	K/W			
Temperature Sensor				
R <sub>ts</sub> 3 %, T <sub>r</sub> = 25 (100) °C 1000(1670)	Ω			
Mechanical Data	-			
w 21,5				
M <sub>s</sub> Mounting torque 2 2,5	g			

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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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